Materials and Properties IV Outgassing

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CERN Accelerator School (CAS) on Vacuum for Particle Accelerators June 18th 2017



www.cern.ch

Dutline

- Gas source and main features.
- Order of magnitude.
- Outgassing of water vapour from metals
- Outgassing of water vapour from polymers
- Outgassing of H₂ from metals

Outline

Preamble: outgassing rate versus pumping speed

The total outgassing rate Q and the effective pumping speed S define the pressure in a vacuum system:

$$P = \frac{Q}{S} + P_0$$

P₀: ultimate pressure of the pumping system.

In general, *in particle accelerators*, the effective S varies between 1 to 1000 I.s⁻¹) while Q **can extend over more than 10 orders of magnitude** ($\approx 10^{-5} \rightarrow 10^{-15}$ mbar I.s⁻¹.cm⁻²).

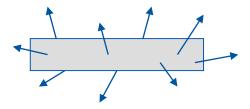
The **right choice of materials and treatments** is compulsory in the design of vacuum systems (especially those for accelerators).

In this respect the measurement of outgassing rate is an essential activity for an ultra-high vacuum expert.

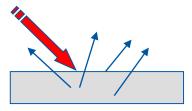


Reminder: Terminology

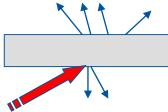
Outgassing is the spontaneous evolution of gas from solid or liquid.



<u>Degassing</u> is the deliberate removal of gas from a solid or a liquid.



<u>Desorption</u> is the release of adsorbed chemical species from the surface of a solid or liquid.

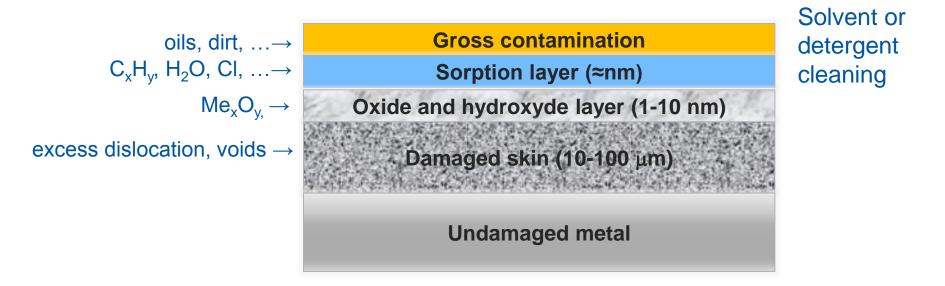




Gas sources

Contamination onto surfaces is a source of gas.

After production, the **surface** of vacuum components is **always contaminated**. They must be **thoroughly cleaned** before installation.



See Mauro Taborelli presentation on Monday 22nd



Outgassing: main features

Gas molecules dissolved in the bulk of materials are also a source of gas.

They diffuse towards the surfaces and are then released.

Polymers dissolve a significant quantity of molecules, in particular H₂O.

Metals can dissolve only **limited quantities** of small atoms that, at room temperature, are immobile in the lattice, except for hydrogen.

In one day, H atoms travel in average $4 \mu m$ in austenitic stainless steels, while O atoms travel the same distance in 1000 years.

Therefore, amongst the dissolved elements in the bulk of metals, **only H**₂ is **released at room temperature**.

For comparison, in one day, H_2O molecules move along about 20 μ m in PEEK, a high-performance polymer.



Outgassing rates: orders of magnitude

Neoprene (10 h pumping): $q_{H2O} \approx 10^{-5} \text{ mbar I s}^{-1} \text{ cm}^{-2}$ $q_{H2O} \approx 10^{14} \text{ molecules s}^{-1} \text{ cm}^{-2}$

Unbaked stainless steel (10 h pumping):

 q_{H2O} =3x10⁻¹⁰ mbar l s⁻¹ cm⁻² q_{H2O} =7x10⁹ molecules s⁻¹ cm⁻²

Baked stainless steel (150° C x 24 h):

 $q_{H2}=3x10^{-12} \text{ mbar I s}^{-1} \text{ cm}^{-2}$ $q_{H2}=7x10^7 \text{ molecules s}^{-1} \text{ cm}^{-2}$ Baked OFS Copper (200° C x 24 h): $q_{H2}=3x10^{-14} \text{ mbar I s}^{-1} \text{ cm}^{-2}$

 q_{H2} =7x10⁵ molecules s⁻¹ cm⁻²

Instruments equipped with hot filaments are an important source of gas.

'Indicative' value for CERN instruments after standard degassing procedure:

Bayard-Alpert gauges (W filaments)

 $Q \approx 10^{-9} \text{ mbar } \ell \text{ s}^{-1}$

 $Q \approx 3 \times 10^{10}$ molecules s⁻¹

Residual gas analyzer (W filaments)

 $Q \approx 10^{-8} \text{ mbar } \ell \text{ s}^{-1}$ $Q \approx 3 \times 10^{11} \text{ molecules s}^{-1}$

Equivalent in quantity to $\approx 1 \text{ m}^2$ of stainless steel.

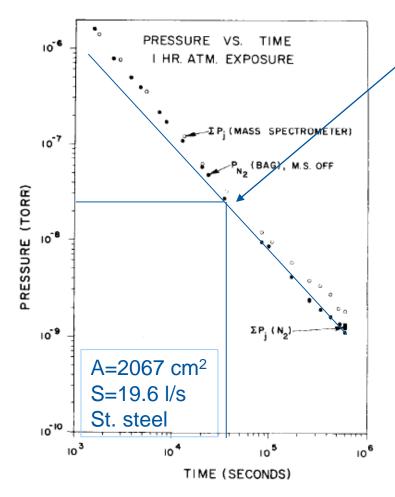


Outgassing of water vapour from unbaked metallic alloys



Outgassing of water vapour

D. Edwards Jr. Journal of Vacuum Science and Tech., 14(1977)606 and 14(1977)1030



 $q(10h) = 2 \times 10^{-10} \text{ Torr I s}^{-1} \text{ cm}^{-2}$

$$q_{H_2O} \approx \frac{3 \times 10^{-9}}{t[h]} \left[\frac{mbar \ l}{s \ cm^2} \right]$$

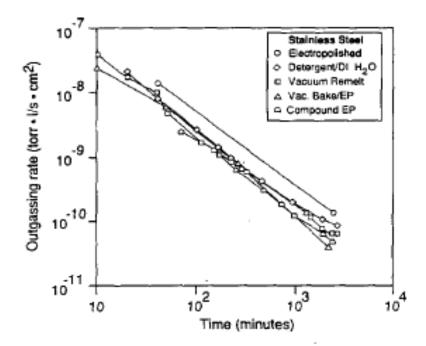
Experimental values valid for all metals used for vacuum chamber manufacturing

The outgassing rate of an unbaked material **depends on pumping time**, it is not an intrinsic value!



Outgassing of water vapour

H.F. Dylla, D. M. Manos, P.H. LaMarche Jr. J. Vac. Sci. and Tech. A, 11(1993)2623



 $q_{H_2O} \approx \frac{3 \times 10^{-9}}{t[h]} \left[\frac{mbar \ l}{s \ cm^2} \right]$

The most effective way to accelerate the release of water vapour is *in-situ* bakeout at least at 120°C for 12 hours.

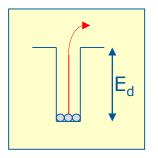
Water vapour outgassing rate of austenitic stainless steel that underwent four different surface treatments.

The source of H₂O is recharged after each venting to air.



Interpretation: single desorption energy

Mean stay time at room temperature



The mean stay time (sojourn time) is given by the Frenckel law:

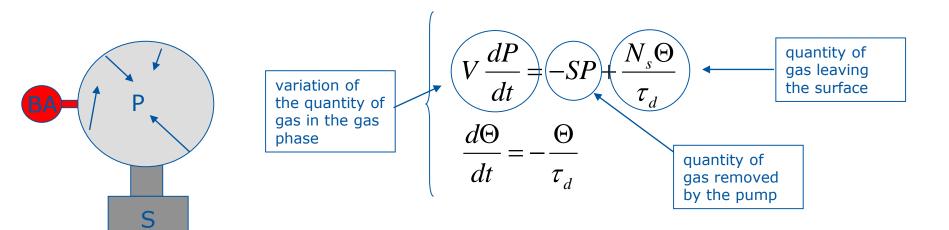
$$au_d = au_o e^{rac{E_d}{k_B T}}$$

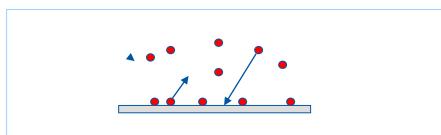
where the value of τ_o is usually assumed to be about 10^{-13} s (\approx h/K_BT).



Interpretation: single desorption energy

Pressure decrease





 Θ = fraction of sites occupied The total number of sites N_s is assumed to be $\approx 10^{15}$ cm⁻² \rightarrow 4x10⁻⁵ mbar l s⁻¹cm⁻²

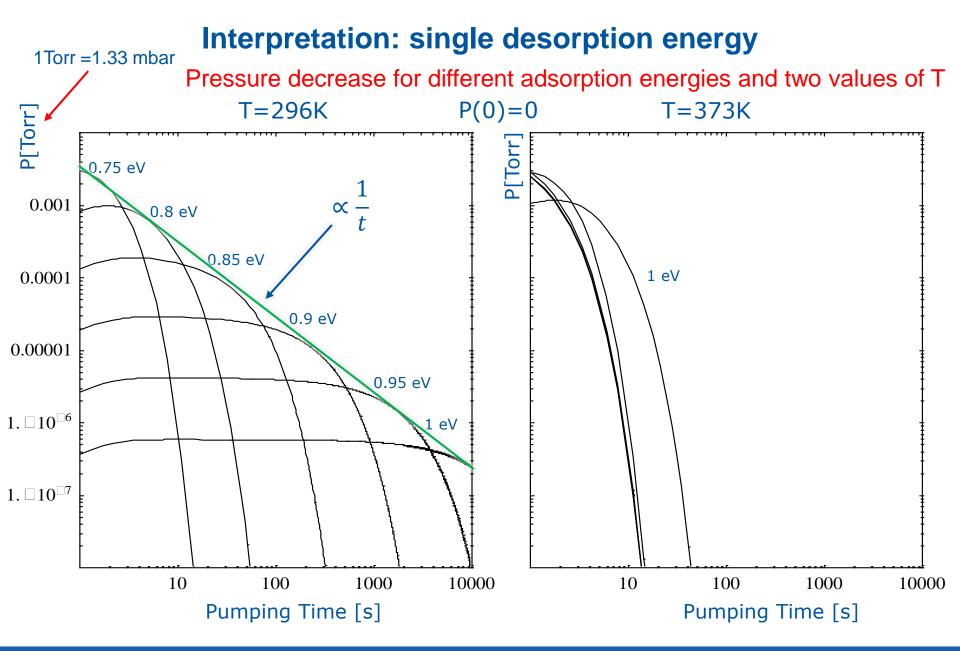
$$P(t) \cong \frac{N_s}{S \cdot \tau_d} e^{-\frac{t}{\tau_d}} \quad \text{for } t > \tau_d$$

The solution is plotted for:

V=10 $\ell,$ S=10 ℓ /s, $N_s{=}2245x4x10^{{\text{-5}}}$ mbar ℓ

and different energies

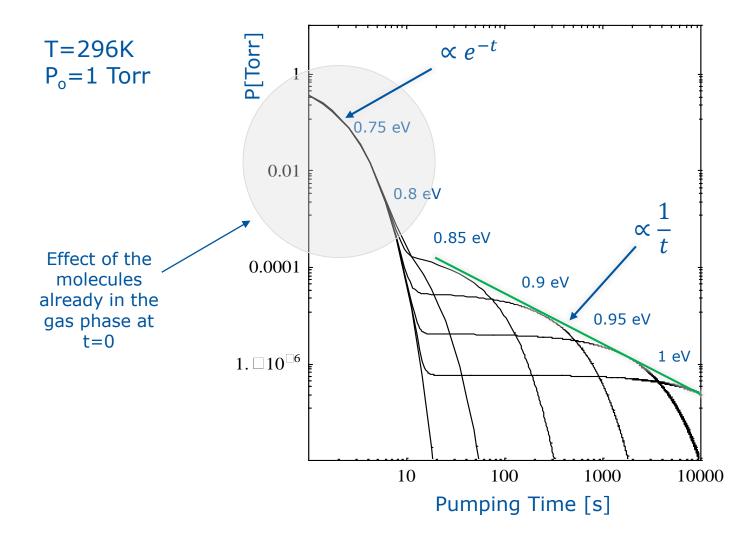






Interpretation: single desorption energy

Pressure decrease for different adsorption energies





Water vapour outgassing from polymers



Polymers, in particular in their amorphous structures, can **dissolve huge quantities of gas**, in particular water vapour.

The water vapour solubility is very high; for example for common materials like Viton, PEEK, and Vespel (Kapton) the content of water in equilibrium with 50%-humidity air at 20°C is 0.21, 0.2, and 1 wt. %, respectively.

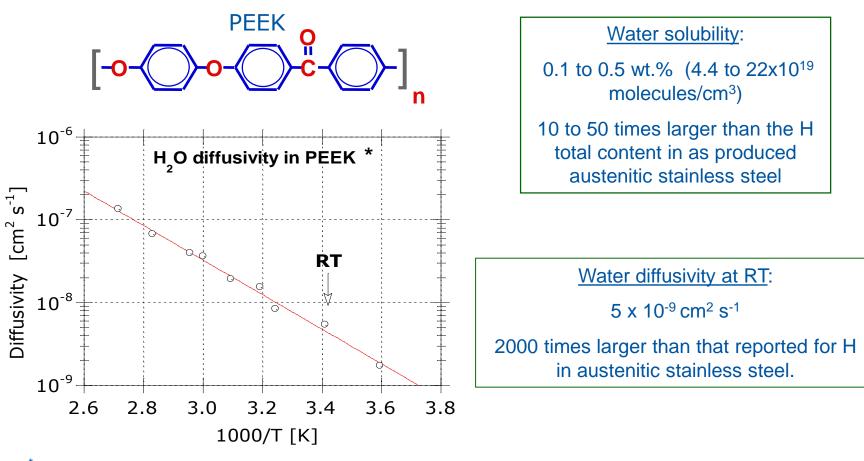
The huge quantity of dissolved gas and the **relatively high mobility** through the polymeric chains result in **much higher outgassing rates** than the ones of metals. This is particularly marked for **water vapour**.

| R. N. | Pea | сос | k, J. | Vac. | S | ci. |
|-------|-------|-----|-------|-------|----|------|
| Techr | ıol., | 17(| (1), | p.330 | Э, | 1980 |

| Polymer | Unbaked, 1 h pumping | Baked, ultimate | | | |
|--------------------|---|---|--|--|--|
| Fluoroelastomer | $4 \times 10^{-7} \cdot 2 \times 10^{-5}$ | $3 \times 10^{-11} - 2 \times 10^{-9}$ | | | |
| Buna-N | $2 \times 10^{-7} - 3 \times 10^{-6}$ | | | | |
| Neoprene | $5 \times 10^{-5} - 3 \times 10^{-4}$ | | | | |
| Butyl | $2 \times 10^{-6} - 1 \times 10^{-5}$ | | | | |
| Polyurethane | 5×10^{-7} | | | | |
| Silicone | $3 \times 10^{-6} - 2 \times 10^{-5}$ | | | | |
| Perfluoroelastomer | 3×10^{-9} | $3 \times 10^{-11} - 3 \times 10^{-10}$ | | | |
| Teflon | $2 \times 10^{-8} - 4 \times 10^{-6}$ | | | | |
| KEL-F | 4×10^{-8} | 3.5×10^{-10} | | | |
| Polyimide | 8×10^{-7} | 3×10^{-11} | | | |

The maximum bakeout temperature depends on the type of polymer; it is limited to about 200 °C for Viton[®].

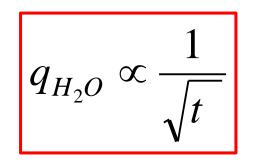
Example:



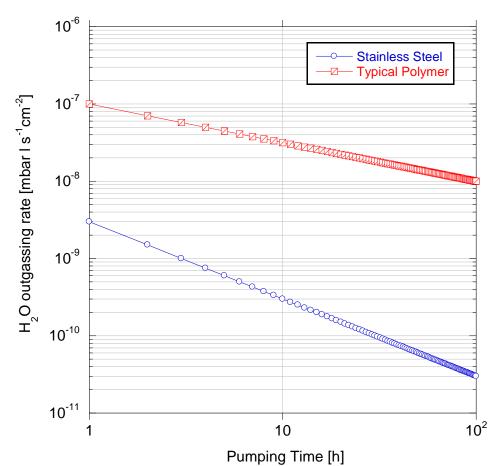
After G.Mensitieri et al., J.Appl.Polym.Sci., **37**, 381, (1989)



The outgassing rates of **thick slab of polymers** decrease with the inverse of the square root of the pumping time t:

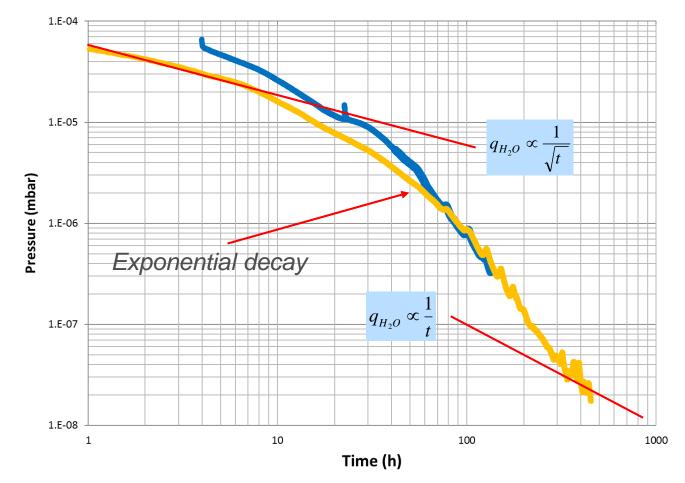


The decrease of water vapour outgassing rate is much slower in polymer than in metals.





Case study: Outgassing of Axon wires, 0.2-mm-thick Kapton insulation



Courtesy of Jose Antonio Ferreira Somoza



- Another important limitation of polymers used as seals is **the high gas permeability.**
- Gas penetrates into the material and diffuses towards the vacuum system. The permeation flow may limit the ultimate water vapour pressure in vacuum systems and affect the sensitivity of helium leak-detection.
- The permeation flow of atmospheric water vapour through a Viton O-ring, 5 mm cross section diameter, 6 cm torus diameter is ≈ 10⁻⁷ Torr I s⁻¹. The stationary condition (ultimate permeation) will be attained after about two months.



Outgassing of H₂ from metals used in vacuum systems for particle accelerators.



Outgassing of hydrogen

For metallic alloys, as soon as water vapour outgassing is strongly reduced, by either long pumping or bakeout, H_2 outgassing rate becomes the highest one.

This gas is dissolved in metals as single H atoms. Its **diffusion is relatively fast** and, after **recombination on the surface**, it can be released as molecular hydrogen.

Most of the **H** atoms are dissolved in liquid metals, during the production process.

H atom mobility and solubility in the liquid state are higher than in the solid state.

Typical sources of H are:

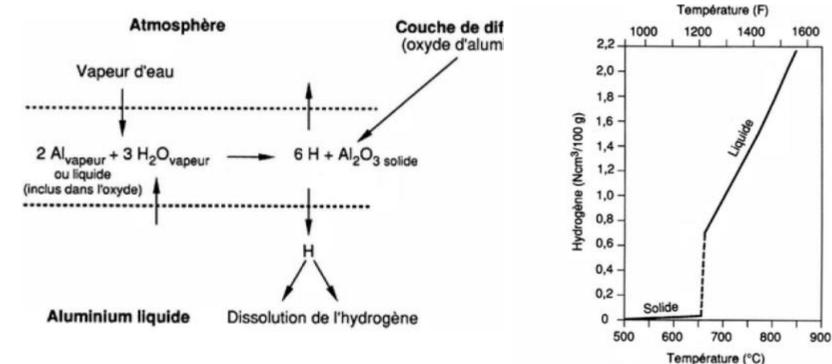
- metals ores;
- tools needed for fusion;
- refractory materials of furnaces;
- combustion and treatment gas;
- water vapour and fluids used for quenching (for example the hyper-quench of austenitic stainless steels is carried out from 1100°C in water, air, or oil).



Outgassing of hydrogen

Example of a process of H_2 dissolution in liquid Al

If the solidification is fast, **the gas is trapped in the solid** far form the equilibrium



Typical H_2 contents are about **1 wt. ppm** for copper, aluminum, and austenitic stainless steel

1 Ncm³ correspond à 1 cm³ de gaz mesuré dans les conditions normales de température (°C) et de pression (10⁵ Pa).



Outgassing of hydrogen

As for water vapour, hydrogen-outgassing rate is reduced by heating.

The high temperatures **increase the H atoms mobility** and, as a result, accelerate the depletion of the residual hydrogen content.

However, there is a crucial difference between water vapour and hydrogen.

Each time the vacuum system is exposed to air, water molecules re-adsorb on the surface, while **hydrogen is not recharged** in the bulk of the metal.

For most of the materials used for the manufacturing of vacuum chambers, the H **solubility is very low** in the solid state.

For example, to recharge **1 wt. ppm** of hydrogen at room temperature in stainless steel, the material has to be in equilibrium with the gas at **7 bar**. The hydrogen pressure in air is roughly 10⁻⁴ mbar, which gives a maximum recharging of about 2.10⁻⁴ wt. ppm.



Outgassing of hydrogen: effect of bakeout

For **copper and aluminium alloys**, a few bakeout at 150-200°C for 24 hours are sufficient to reduce the hydrogen-outgassing rate to less than 10⁻¹³ mbar l s⁻¹ cm⁻².

For **austenitic stainless steel**, higher temperatures are needed to have a similar effect for a few-mm-thick vacuum chambers. Repeated bakeout at temperature higher than 200°C may have a significant influence.

| Materials | Bakeout T[°C] x 24 h | q [mbar l s ⁻¹ cm ⁻²] |
|---------------------------|-------------------------|---|
| Austenitic st. steel | 150 | 3 10 ⁻¹² |
| Austenitic st. steel | 200 | 2 10 ⁻¹² |
| Austenitic st. steel | 300 | 5 10 ⁻¹³ |
| Copper Silver added (OFS) | 150 | 3 10 ⁻¹² |
| Copper Silver added (OFS) | 200 | ≈ 10 ⁻¹⁴ |
| Beryllium after brazing | 150 | < 10 ⁻¹⁴ |
| Al alloys | 150 | < 10 ⁻¹³ |



For austenitic stainless steels, a radical effect is obtained by heating in a vacuum furnace to temperatures up to about 1000°C.

Such a treatment is called 'vacuum firing'. At CERN, it is carried out at 950°C for 2 h.





The **CERN's large furnace**: useful height and diameter: 6 m and 1 m, respectively. Maximum charge weight: 1000 Kg. Ultimate pressure: about 10⁻⁷ mbar; pressure at the end of the 950°Cx2h treatments: 10⁻⁵mbar.



> *T* < 500°C

H atom diffusion in austenite is too slow

> 500°C (600°C)< T < 900°C (depending on the steel grade)

carbide and carbo-nitride precipitation

residual δ -ferrite transformation into σ - phase (very brittle)

≻ *T* > 1050°C

Solution annealing, abnormal grain growth, recrystallisation, excessive nitrogen loss



| Thermal treatment | Outgassing rate [mbar I s ⁻¹ cm ⁻²] | Comment |
|-------------------|---|--|
| 200°C x 24 h | 2 x 10 ⁻¹² | |
| 300°C x 24 h (*) | 5 x 10 ⁻¹³ | 1.5 mm thick |
| Vacuum firing(*) | ≈ 5 x 10 ⁻¹⁵ | 950°C x 2 h $P_{H2}=2x10^{-5}$ mbar 1.5-mm-thick slabs |

(*) J-P Bojon, N. Hilleret, B. Versolatto

 H_2 outgassing value for vacuum-fired beam pipes assumed for **design of vacuum** systems in the ISR era : **2 x 10⁻¹³** mbar I s⁻¹ cm⁻².



Modification of mechanical and metallurgical properties after vacuum firing

| | As received | Fired 950° C |
|----------------------|----------------|-----------------|
| 304L (UHV use) | 150 | 128 |
| 316LN | 155 | 151 |

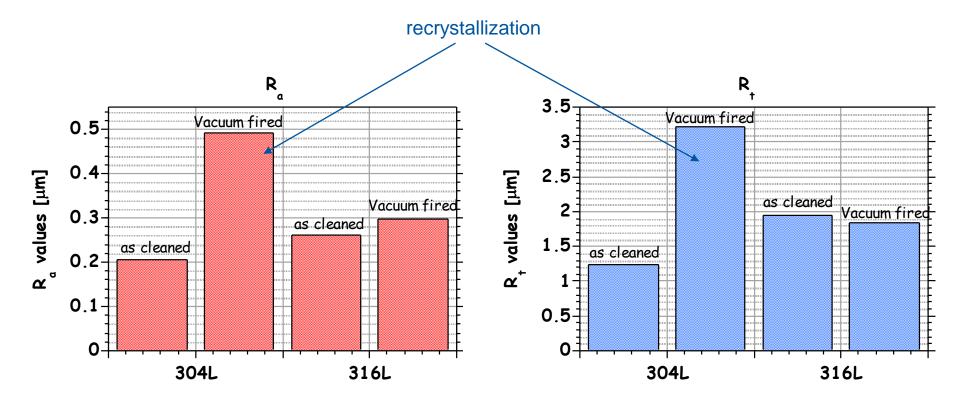
Hardness HB (ISO 6506)

No additional precipitates have been detected after vacuum firing at 950° C

No significant variation of "rupture strength" and "stretch at break": less than 5%

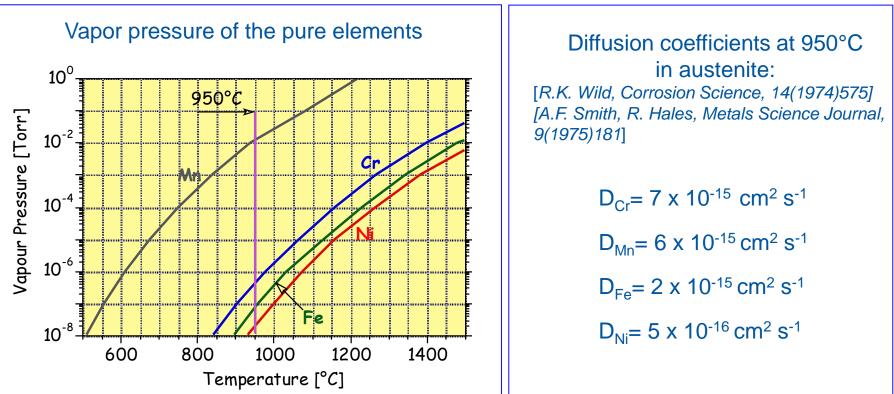


Modification of the surface roughness induced by vacuum firing





Sublimation of metallic elements during vacuum firing



- After vacuum firing the oxide layer is strongly enriched with Fe: Cr/Fe= 0.33 for 316L and 0.22 for 304L (0.75 for cleaned); oxide thickness as for cleaned.
- Cr2p^{2/3} and O1s lines indicate the presence of less hydroxides than on cleaned samples (Cr₂O₃ and Fe₂O₃)
 J. Gavillet and M. Taborelli, unpublished results

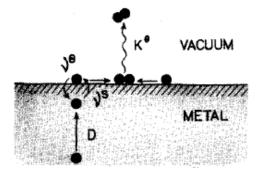


BN surface segregation

- At temperature higher than 700°C, boron segregates to the surface and, in N added stainless steels (316LN), can form h-BN. Heating temperatures higher than 1150°C are needed to dissolve the h-BN layer.
- > BN does not form for B concentration lower than 9 ppm.
- When the concentration is equal or larger than 9 ppm BN forms only when B is free to move, namely not blocked in BN precipitates already existing in the steel bulk.
- The BN layer strongly reduces the surface wettability and may produce peel-off of thin film coatings.
- > The BN layer can be effectively removed by electropolishing.



Theory of hydrogen outgassing: two models



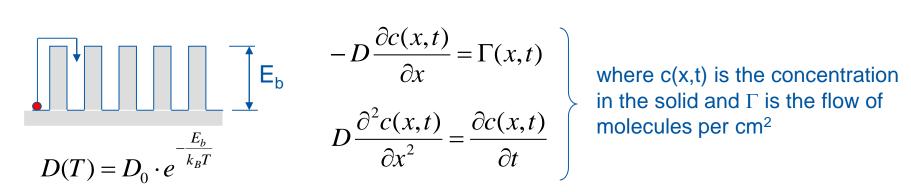
Two limiting mechanisms are considered:

- 1. diffusion limited outgassing $\rightarrow q(t) \propto -\frac{\partial c}{\partial x}$
- 2. recombination limited outgassing $\rightarrow q(t) \propto (c_w)^2$



Theory of hydrogen outgassing: diffusion

Diffusion, in most of the cases of interest, is described by the **Fick's equations**:

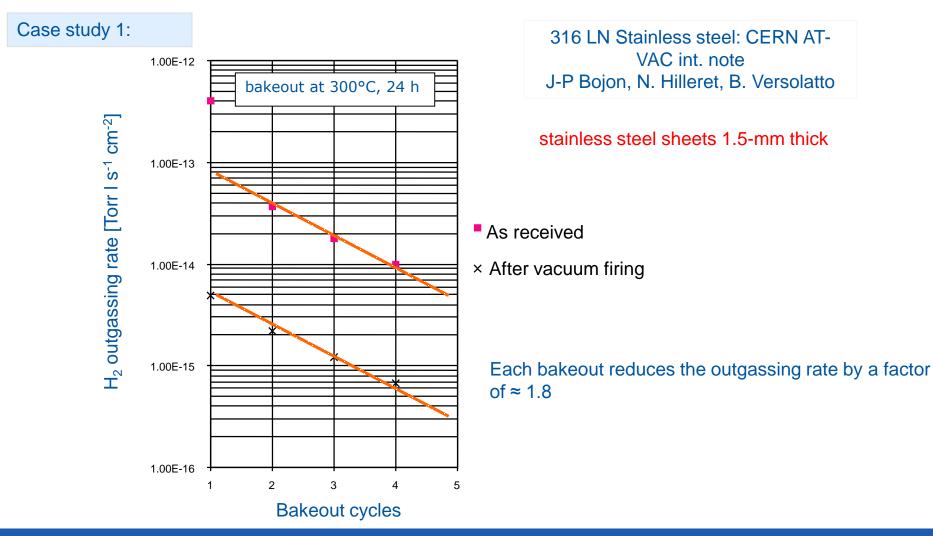


In the limit of this model, the outgassing rate is equal to a half of the flux of atoms arriving at the surface by diffusion (2 H atoms = $1 H_2$ molecule):

$$q(t) = -\frac{1}{2} D \frac{\partial c(x,t)}{\partial x} \bigg|_{x=SURF.}$$

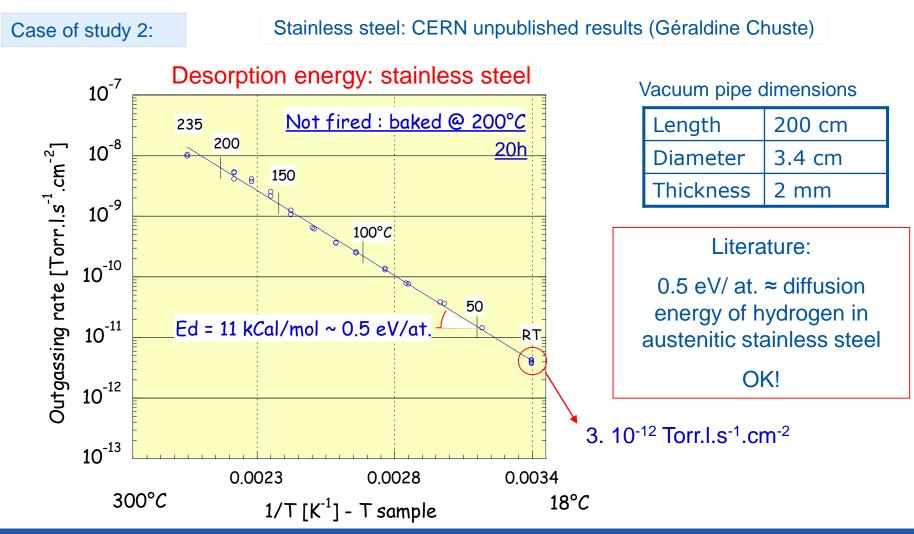


Diffusion model of H₂ outgassing: slab approximation

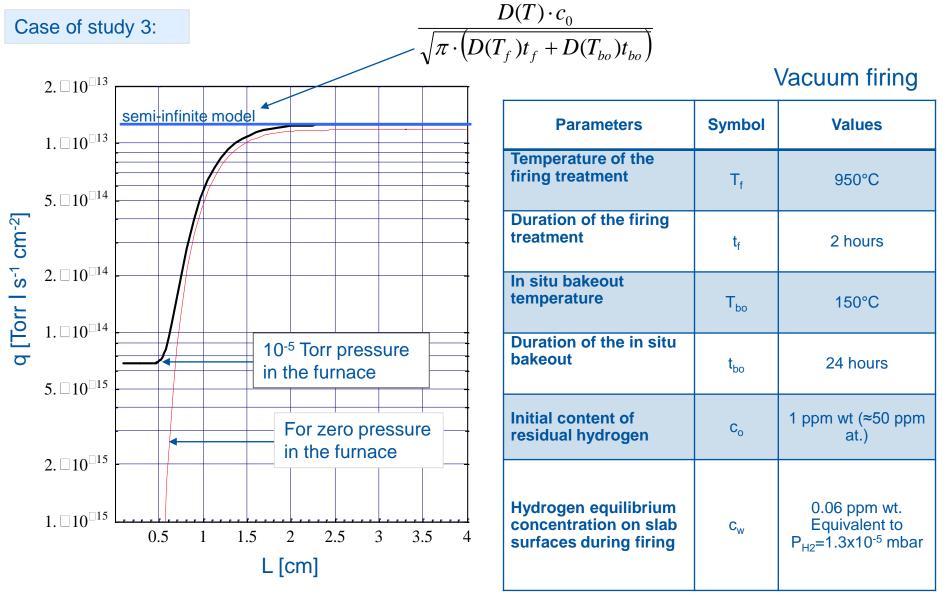




Diffusion model of H₂ outgassing: slab approximation





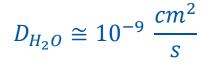


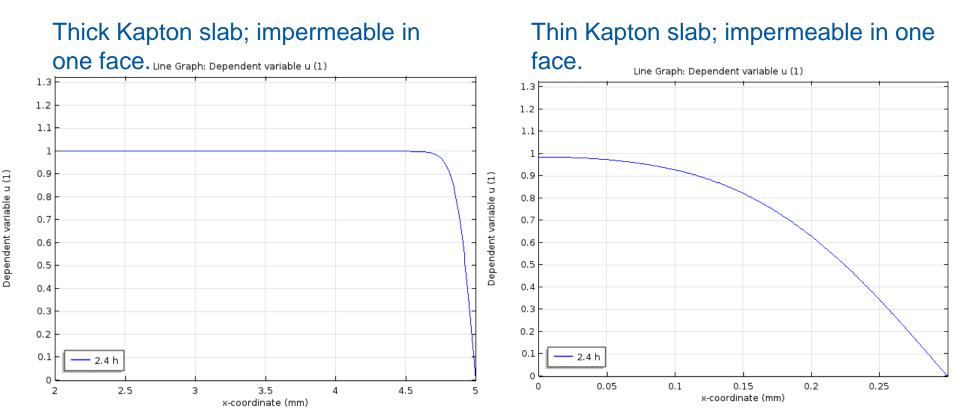


Case of study 4:

Water in polymers

Chosen value for diffusivity of water molecules in polyimide:







Outgassing databases: be attentive!

Ti 6AI 4V ?

Google: 'outgassing vacuum materials'

Princeton Plasma Physics Lab

http://ncsx.pppl.gov/NCSX_Engineering/Materials/VacuumMaterials/Outgassing_Data.pdf

Fermi National Accelerator Laboratory

http://lss.fnal.gov/archive/tm/TM-1615.pdf

http://home.fnal.gov/~mlwong/outgas_rev.htm#ss NASA

https://outgassing.nasa.gov/

Vacom

https://www.vacom.de/en/downloads/whitepapers?download=3024:outgassing-rates-of-aluminum-compared-tostainless-steel



| | | | | | | | | | PPL | | | | - |
|--------------------------|------------------------|--------|------|----------------|-----------|--------|-----------|------------|---------------|-----|--------------------|---------------------|----------|
| PRINCETO PLASMA PHYS | - | | | | ENGINE | RING | TECHNICAL | MEMORANDUM | PREFIX ETM | | UME -001 | IT NO. | REV A |
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| A CO | MPILATI | ON C |)F 0 | UTGA | SSING DAT | A ON V | ACUUM MAT | TERIALS | APPRON | ED | <u> </u> | Mos | hoi |
| | | | | | | | | | APPRO | /ED | | 1 | / |
| CATEGORY II | | 1 | | | | | | | • | | | | |
| KAPTON (H-FILM) | 1 x 10 ⁻¹¹ | 25-150 | DUP | 2 | | | | | | | | | |
| KAPTON (H-FILM) | 8 x 10 ⁻⁷ | 300 | DUP | Gen. Atomic | | | | | | | | | |
| POLYIMIDE SP-1 | 9 x 10 ⁻⁹ | 250 | DUP | Gen. | | | | | | | | | |
| TITANIUM 6AL4V | 1.8 x 10 ⁻⁹ | - | | 7 | > | | | | | | | | |
| VITON E60C | 1 10 | 225 | DUP | 2 | | | | | | | | | |

Vacuum/volume 31/number 8/9 pages 351 to 357/1981 Printed in Great Britain

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2 x 1

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1 x 10⁻⁷

0042-207X/81/080351-07\$02.00/0 Pergamon Press Ltd

Space environment and vacuum properties of spacecraft materials

T J Patrick, University College London. Mullard Space Science Laboratory, Holmbury St Mary, Dorking, Surrey RH5 6NT, UK



VITON EGOC

VITON - A

*Torr-liter-sec⁻¹cm⁻²

Table 1. Some spacecraft materials typical of current practice, listed in approximate order of outgassing rate, with Total Mass Loss (TML) and Condensed Volatile Condensible Material (CVCM); after Campbell *et al*³⁷ or ESA³⁸ (ESA results denoted E)

| Material | Application | Manufacturer | TML (°₀) | | CVCM (° _o) | Outgassing rate, (torr 1 s ⁻¹ cm ²) | 10 h Elsey ²³ (Pa m s ⁻¹) |
|---|--------------------|--------------|---------------|---|---------------------------|---|---|
| Steel, stainless, BS 1449 321 S 12 | Fittings | | - | | | 1.4 × 10 ⁻⁹ | 1.9×10-6 |
| Titanium 6 AI 4 V (IMI 318) | Fittings | | | | | 1.8×10^{-9} | 2.4×10^{-6} |
| Aluminium 4 Cu | Structure | | | | | 3.5×10^{-8} | 4.7×10^{-5} |
| PTFE, Teflon | Wire sleeving | Du Pont | 0.00 | | 0 | 2.5 × 10 ⁻⁸ | 3.3 × 10 ^{~ 5} |
| PTFE-glass-MoS ₂ composite, Duroid | Bearings | Rogers | 0.01 | | 0 | | |
| Perfluoroether, Fomblin | Oil and grease | Montedison | 0.01 | | 0 | | |
| FEP, Teflon, film | Thermal insulation | Du Pont | 0.02 | | 0 | | |
| Fiberglass woven cloth, Betacloth | Thermal insulation | Stevens | 0.03 | | 0. | | |
| Viton A fluorocarbon rubber | Seals | Du Pont | 0.22 | | 0.02 | ~10-7 | ~10-4 |
| Silicone elastomer, 93500 | Potting, seals | Dow Corning | 0.30 | Е | 0.03 | | |
| PETP, Mylar, film | Thermal insulation | | ∫0.30 | Ε | 0.03 | | |
| | | | 0.65 | | 0.04 | 4×10^{-7} | 5.3×10^{-4} |
| Epoxy-glass laminate | Circuit board | | 0.37 | | 0.02 | | |
| Epoxy, Araldite F, hot-cured | Potting | CIBA | 0.40 | Ε | 0 | | |
| Diallyl phthalate | Connector bodies | | 0.44 | | 0 | | |
| Polyurethane, Solithane 113/300 | Conformal coating | Thiokol | <i>∫</i> 0.40 | Ε | 0.03 | | |
| | | | }0.50 | | 0.03 | | |
| Polyimide, Vespel | Solid lubricant | Du Pont | 0.58 | | 0.01 | | |
| Polyacetal, Delrin | Insulating parts | Du Pont | 0.58 | | 0.06 | | |
| PETP, Dacron, tape 21 D 96 | Wire lacing | Gude | 0.73 | | 0.15 | | |
| Epoxy, Araldite AV 100/HV 100 | Adhesive | CIBA | ∫0.78 | | 0.10 | $\sim 10^{-6}$ | $\sim 10^{-3}$ |
| | | | 1.10 | Ε | 0.07 | | |
| Polyolefin, heat shrunk | Sleeving | Raychem | 0.80 | | 0.08 | | |
| Polyimide, Kapton H, film | Thermal insulation | Du Pont | 1.30 | | 0.02 | | |
| Polyurethane Z 306 | Paint | Hughson | <i>§</i> 1.17 | | 0.07 | | |
| - | | - | 1.50 | Ε | 0.03 | | |
| Polyurethane H 322 | Conducting paint | Hughson | \$1.39 | | 0.08 | | |
| - | | - | 1.60 | Е | 0.04 | | |
| Resin loctite AA/primer N | Thread locking | | 1.64 | | 0 | | |



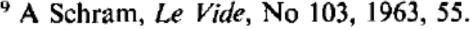
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Outgassing of vacuum materials—II

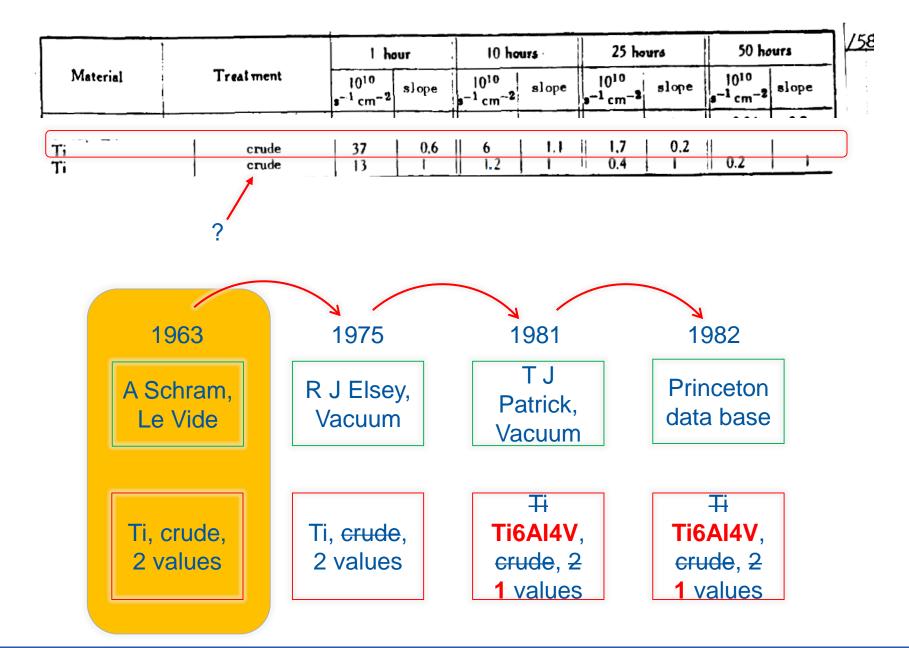
R J Elsey, The Rutherford Laboratory, Chilton, England

A paper in our Education Series: The Theory and Practice of Vacuum Science and Technology in Schools and Colleges.

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|----------|-----|-----|------|-----------------|----|
| Titanium | 113 | 0.6 | 18.4 | ĭ.ĭ | 9 |
| Titanium | 40 | 1.0 | 3.68 | 1 | 9 |
| | | | | | ~ |









Conclusions

Outgassing rates depends on materials and treatments.

For **unbaked metals**, **water vapour is the leading outgassed** molecule. Its outgassing rate is **inversely proportional to the pumping time**. It is not strongly dependent on treatment and grade. Venting to air cancel the effect of previous gas release,

Multi-energy adsorption models explain the pressure decrease.

For **baked metals**, the outgassing process is **dominated by hydrogen**. It depends on the nature of the material and, **strongly, on the applied thermal treatment**. **Venting to air does not recharge hydrogen** into solid metal used for vacuum chambers.

Diffusion theory explains the measured data and is predictive for hydrogen content and wall thicknesses generally used for particle accelerators.

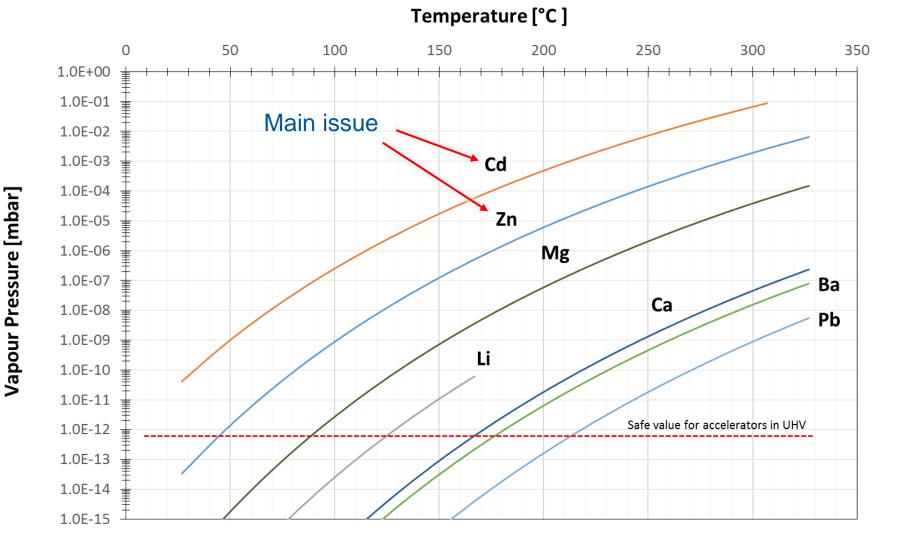
Organic materials absorb and release much more gas than metals; their gas release rate is higher and lasts longer than metallic alloys. **Avoid any polymer** (if you can)!



Thanks for your attention



Vapour pressure of pure metals



https://www.iap.tuwien.ac.at/www/surface/vapor_pressure



Reminder: Units of gas quantity

- The quantity of gas can be presented in number of molecules (N) or in pressurevolume (PV) units.
- The two values are related by the ideal gas equation of state:

$$P \cdot V = N \cdot k_B \cdot T \to N = \frac{P \cdot V}{k_B \cdot T}$$

- The pressure-volume units are transformed to number of molecules when divided by $k_{\rm B} \mbox{T}.$
- The same number of molecules is expressed by different pressure-volume values at different temperatures. In general, the pressure-volume quantities are quoted at room temperature: 296 K.

$$k_{B} = 1.38 \cdot 10^{-23} \left[\frac{N \cdot m}{K} = \frac{Pa \cdot m^{3}}{K} \right]$$
$$k_{B} = 1.38 \cdot 10^{-23} \left[\frac{Pa \cdot m^{3}}{K} \right] = 1.04 \cdot 10^{-22} \left[\frac{Torr \cdot \ell}{K} \right] = 1.38 \cdot 10^{-22} \left[\frac{mbar \cdot \ell}{K} \right]$$
$$for T = T_{RT} = 296 \text{ K}$$
$$\frac{1}{k_{B}T_{RT}} = 2.45 \cdot 10^{20} \left[Pa \cdot m^{3} \right]^{-1} = 3.3 \cdot 10^{19} \left[Torr \cdot \ell \right]^{-1} = 2.5 \cdot 10^{19} \left[mbar \cdot \ell \right]^{-1}$$



